



UPDATE CHANGE NOTIFICATION
Generic Copy

29 Nov 2007

SUBJECT: ON Semiconductor Update Notification #16074

TITLE: Correction to SUBJECT line of FPCN16063 - Addition of ON Semiconductor Seremban Assembly/Test Site for High Frequency, 8 Lead TSSOP Package

PROPOSED FIRST SHIP DATE: n/a

AFFECTED CHANGE CATEGORY(S): n/a

AFFECTED PRODUCT DIVISION(S): n/a

ADDITIONAL RELIABILITY DATA: n/a

SAMPLES: Contact your local ON Semiconductor Sales

FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local ON Semiconductor Sales Office or Clarence Rebello <C.Rebello@onsemi.com>

NOTIFICATION TYPE:

ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact your local ON Semiconductor Sales Office.

DESCRIPTION AND PURPOSE:

The purpose of this update notification is to correct the Subject line of FPCN #16063:

From **SUBJECT: ON Semiconductor Initial Product/Process Change Notification #16063**
To **SUBJECT: ON Semiconductor Final Product/Process Change Notification #16063**